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Kind regards,

Team Nexperia

# BAS70 series; 1PS7xSB70 series

**General-purpose Schottky diodes** 

Rev. 09 — 13 January 2010

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

General-purpose Schottky diodes in small Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

Type number	Package		Configuration
	NXP	JEITA	
1PS76SB70	SOD323	SC-76	single diode
1PS79SB70	SOD523	SC-79	single diode
BAS70	SOT23	-	single diode
BAS70H	SOD123F	-	single diode
BAS70L	SOD882	-	single diode
BAS70W	SOT323	SC-70	single diode
BAS70-04	SOT23	-	dual series
BAS70-04W	SOT323	SC-70	dual series
BAS70-05	SOT23	-	dual common cathode
BAS70-05W	SOT323	SC-70	dual common cathode
BAS70-06	SOT23	-	dual common anode
BAS70-06W	SOT323	SC-70	dual common anode
BAS70-07	SOT143B	-	dual isolated
BAS70-07S	SOT363	SC-88	dual isolated
BAS70-07V	SOT666	-	dual isolated
BAS70VV	SOT666	-	triple isolated
BAS70XY	SOT363	SC-88	quadruple; 2 series

#### 1.2 Features

- High switching speed
- High breakdown voltage
- Low leakage current
- Low capacitance

#### 1.3 Applications

- Ultra high-speed switching
- Voltage clamping



#### 1.4 Quick reference data

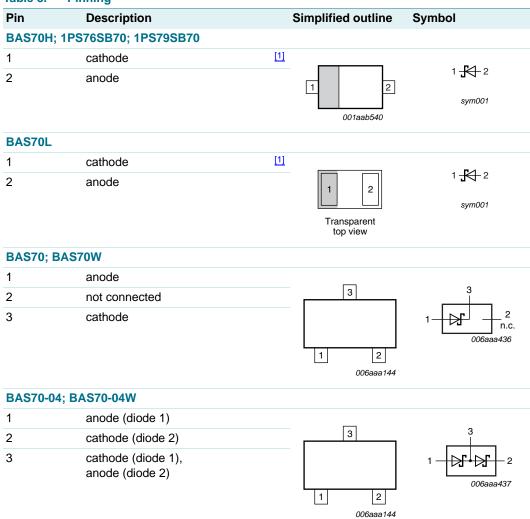
Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
I <sub>F</sub>	forward current		-	-	70	mA
V <sub>F</sub>	forward voltage	$I_F = 1 \text{ mA}$	<u>[1]</u> _	-	410	mV
V <sub>R</sub>	reverse voltage		-	-	70	V

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

## 2. Pinning information

Table 3. Pinning



BAS70\_1PS7XSB70\_SER\_9 © NXP B.V. 2010. All rights reserved.

## BAS70 series; 1PS7xSB70 series

**General-purpose Schottky diodes** 

 Table 3.
 Pinning ...continued

Pin	Description	Simplified outline	Symbol		
BAS70-0	5; BAS70-05W				
1	anode (diode 1)		_		
2	anode (diode 2)	3	3		
3	cathode (diode 1), cathode (diode 2)	1 2 006aaa144	1 2 006aaa438		
BAS70-0	6; BAS70-06W				
1	cathode (diode 1)	_			
2	cathode (diode 2)	3	3		
3	anode (diode 1), anode (diode 2)	1 2 006aaa144	1 2 006aaa439		
BAS70-0	7				
1	cathode (diode 1)	4 0	4 2		
2	cathode (diode 2)	4 3	4 3		
3	anode (diode 2)		🔻 🔻		
4	anode (diode 1)	1 2	1 2 006aaa434		
BAS70-0	7S; BAS70-07V				
1	anode (diode 1)				
2	not connected	6 5 4	6 5 4		
3	cathode (diode 2)				
4	anode (diode 2)				
5	not connected		1 2 3 <i>006aaa440</i>		
6	cathode (diode 1)	001aab555			
BAS70V\	I				
1	anode (diode 1)				
2	anode (diode 2)	6 5 4	6 5 4		
3	anode (diode 3)				
4	cathode (diode 3)				
5	cathode (diode 2)		1 2 3		

6

3 of 20

sym046

cathode (diode 2)

cathode (diode 1)

 Table 3.
 Pinning ...continued

Pin	Description	Simplified outline	Symbol
BAS70XY			
1	anode (diode 1)		
2	cathode (diode 2)	654	6 5 4
3	anode (diode 3), cathode (diode 4)	0	
4	anode (diode 4)	1 2 3	
5	cathode (diode 3)		
6	cathode (diode 1), anode (diode 2)		1 2 3 006aaa256

<sup>[1]</sup> The marking bar indicates the cathode.

## 3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
1PS76SB70	SC-76	plastic surface-mounted package; 2 leads	SOD323
1PS79SB70	SC-79	plastic surface-mounted package; 2 leads	SOD523
BAS70	-	plastic surface-mounted package; 3 leads	SOT23
BAS70H	-	plastic surface-mounted package; 2 leads	SOD123F
BAS70L	-	leadless ultra small plastic package; 2 terminals; body 1.0 $\times$ 0.6 $\times$ 0.5 mm	SOD882
BAS70W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-04	-	plastic surface-mounted package; 3 leads	SOT23
BAS70-04W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-05	-	plastic surface-mounted package; 3 leads	SOT23
BAS70-05W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-06	-	plastic surface-mounted package; 3 leads	SOT23
BAS70-06W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS70-07	-	plastic surface-mounted package; 4 leads	SOT143B
BAS70-07S	SC-88	plastic surface-mounted package; 6 leads	SOT363
BAS70-07V	-	plastic surface-mounted package; 6 leads	SOT666
BAS70VV	-	plastic surface-mounted package; 6 leads	SOT666
BAS70XY	SC-88	plastic surface-mounted package; 6 leads	SOT363

## 4. Marking

Table 5. Marking codes

Type number	Marking code[1]	Type number	Marking code[1]
1PS76SB70	S2	BAS70-05W	75*
1PS79SB70	G	BAS70-06	76*
BAS70	73*	BAS70-06W	76*
BAS70H	AH	BAS70-07	77*
BAS70L	S8	BAS70-07S	77*
BAS70W	73*	BAS70-07V	77
BAS70-04	74*	BAS70VV	N1
BAS70-04W	74*	BAS70XY	70*
BAS70-05	75*	-	-

<sup>[1] \* = -:</sup> made in Hong Kong

## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
$V_R$	reverse voltage		-	70	V
I <sub>F</sub>	forward current		-	70	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p \leq 1 \text{ s; } \delta \leq 0.5$	-	70	mA
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p \le 10 \text{ ms}$	[1] -	100	mA
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup>  $T_j = 25$  °C prior to surge.

<sup>\* =</sup> p: made in Hong Kong

<sup>\* =</sup> t: made in Malaysia

<sup>\* =</sup> W: made in China

### 6. Thermal characteristics

Table 7. Thermal characteristics

Table 7.	i nermai characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device	e					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	SOT23		-	-	500	K/W
	SOT143B		-	-	500	K/W
	SOT363 (BAS70-07S)		-	-	416	K/W
	SOT666 (BAS70VV)		[2]	-	700	K/W
	SOT666 (BAS70-07V)		[2]	-	416	K/W
	SOD123F		[2]	-	330	K/W
	SOD323		-	-	450	K/W
	SOD523		[2]	-	450	K/W
	SOD882		[2] _	-	500	K/W
	SOT323		-	-	625	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point					
	SOT363 (BAS70XY)		[3] _	-	260	K/W

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

#### 7. Characteristics

Table 8. Characteristics

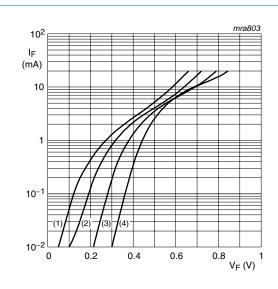
 $T_{amb} = 25$  °C unless otherwise specified.

Parameter	Conditions	Min	Тур	Max	Unit
•					
forward voltage		[1]			
	I <sub>F</sub> = 1 mA	-	-	410	mV
	I <sub>F</sub> = 10 mA	-	-	750	mV
	I <sub>F</sub> = 15 mA	-	-	1	V
reverse current	V <sub>R</sub> = 50 V	-	-	100	nA
	V <sub>R</sub> = 70 V	-	-	10	μΑ
diode capacitance	$V_R = 0 V$ ; $f = 1 MHz$	-	-	2	pF
	forward voltage reverse current	forward voltage $\begin{array}{c} I_F = 1 \text{ mA} \\ I_F = 10 \text{ mA} \\ I_F = 10 \text{ mA} \\ I_F = 15 \text{ mA} \\ \end{array}$ reverse current $\begin{array}{c} V_R = 50 \text{ V} \\ V_R = 70 \text{ V} \end{array}$	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

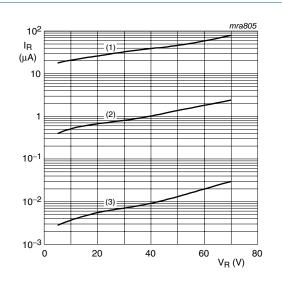
<sup>[2]</sup> Reflow soldering is the only recommended soldering method.

<sup>[3]</sup> Soldering point at pins 2, 3, 5 and 6.



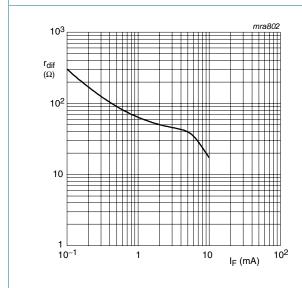
- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$
- (4)  $T_{amb} = -40 \, ^{\circ}C$

Fig 1. Forward current as a function of forward voltage; typical values



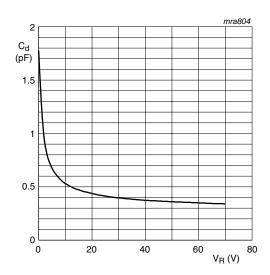
- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values



f = 10 kHz

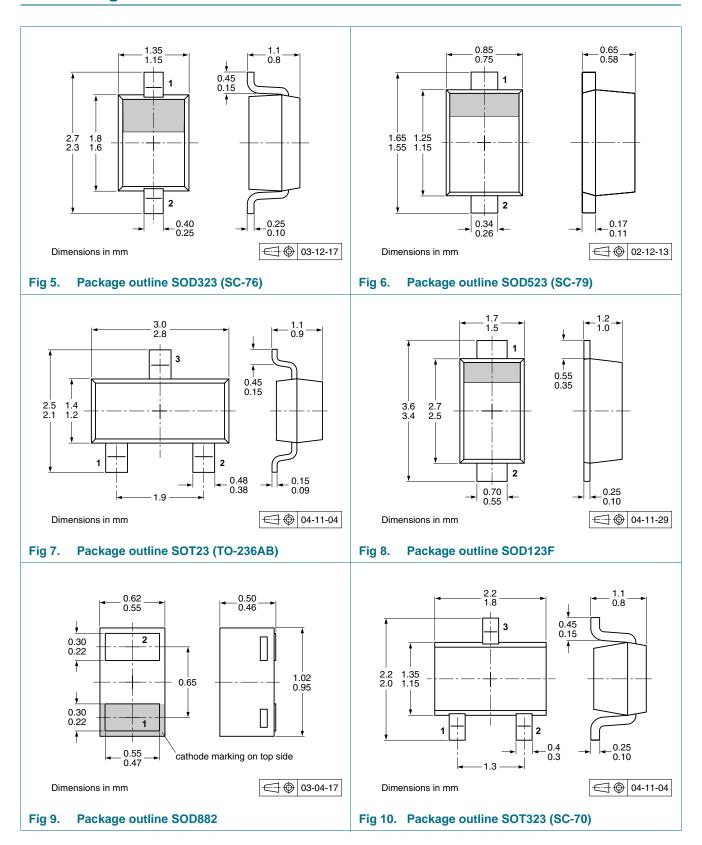
Fig 3. Differential forward resistance as a function of forward current; typical values

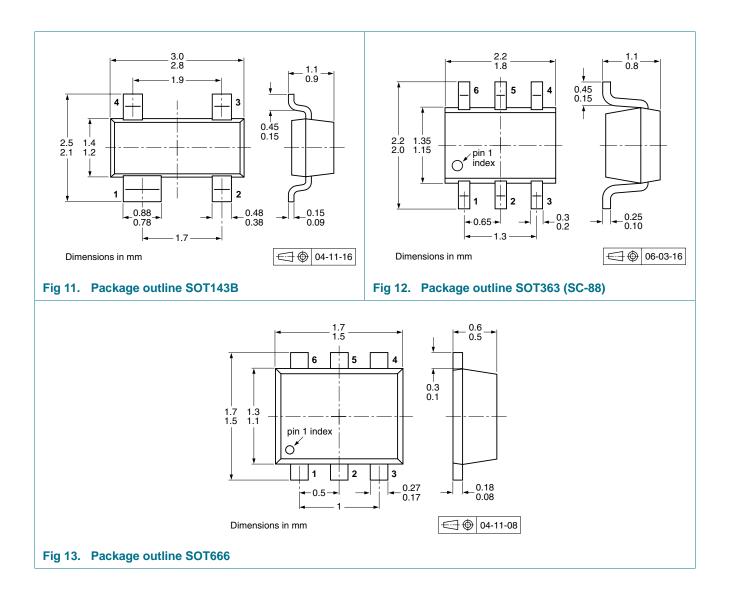


 $T_{amb} = 25 \, ^{\circ}C; f = 1 \, MHz$ 

Fig 4. Diode capacitance as a function of reverse voltage; typical values

## 8. Package outline





## 9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

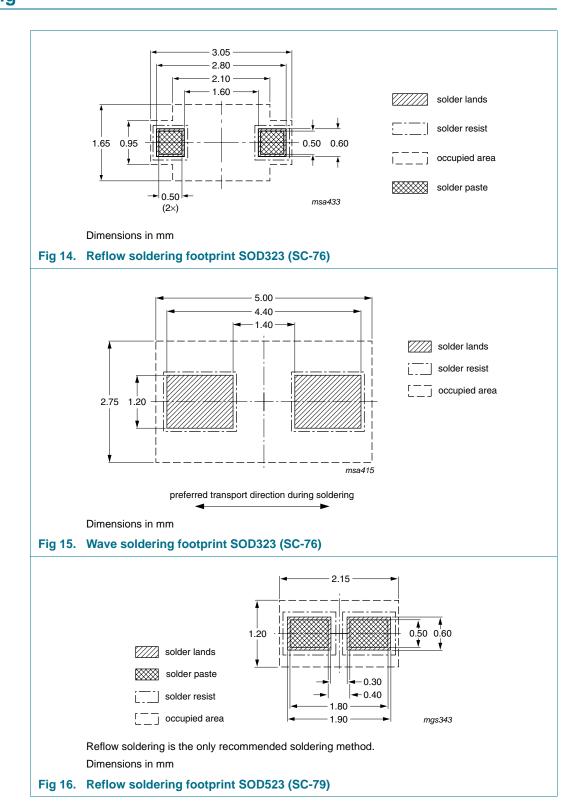
Type number Package		Description		Packing quantity			
			30	000	4000	8000	10000
1PS76SB70	SOD323	4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
1PS79SB70	SOD523	2 mm pitch, 8 mm tape and reel	-		-	-315	-
		4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
BAS70	SOT23	4 mm pitch, 8 mm tape and reel	-2	15	-	-	-235
BAS70H	SOD123F	4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
BAS70L	SOD882	2 mm pitch, 8 mm tape and reel	-		-	-	-315
BAS70W	SOT323	4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
BAS70-04	SOT23	4 mm pitch, 8 mm tape and reel	-2	15	-	-	-235
BAS70-04W	SOT323	4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
BAS70-05	SOT23	4 mm pitch, 8 mm tape and reel	-2	15	-	-	-235
BAS70-05W	SOT323	4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
BAS70-06	SOT23	4 mm pitch, 8 mm tape and reel	-2	15	-	-	-235
BAS70-06W	SOT323	4 mm pitch, 8 mm tape and reel	-1	15	-	-	-135
BAS70-07	SOT143B	4 mm pitch, 8 mm tape and reel	-2	15	-	-	-235
BAS70-07S	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2] -1	15	-	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3] -1	25	-	-	-165
BAS70-07V	SOT666	2 mm pitch, 8 mm tape and reel	-		-	-315	-
		4 mm pitch, 8 mm tape and reel	-		-115	-	-
BAS70VV	SOT666	2 mm pitch, 8 mm tape and reel	-		-	-315	-
		4 mm pitch, 8 mm tape and reel	-		-115	-	-
BAS70XY	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2] -1	15	-	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3] -1	25	-	-	-165

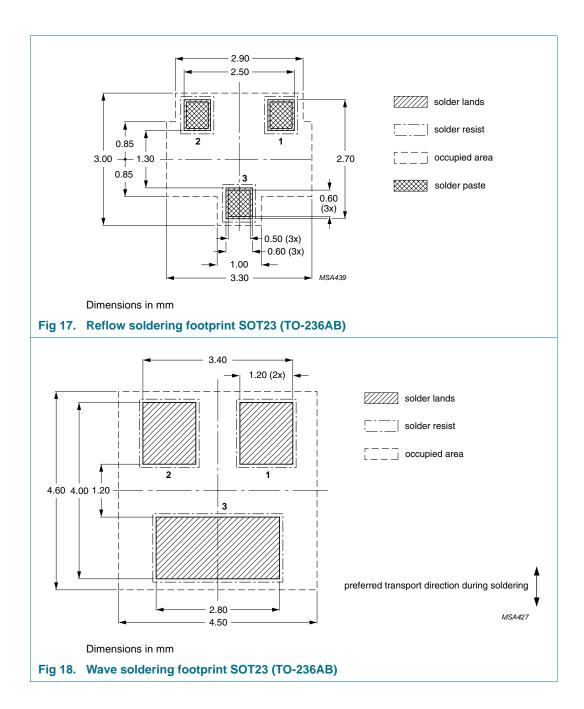
<sup>[1]</sup> For further information and the availability of packing methods, see <u>Section 13</u>.

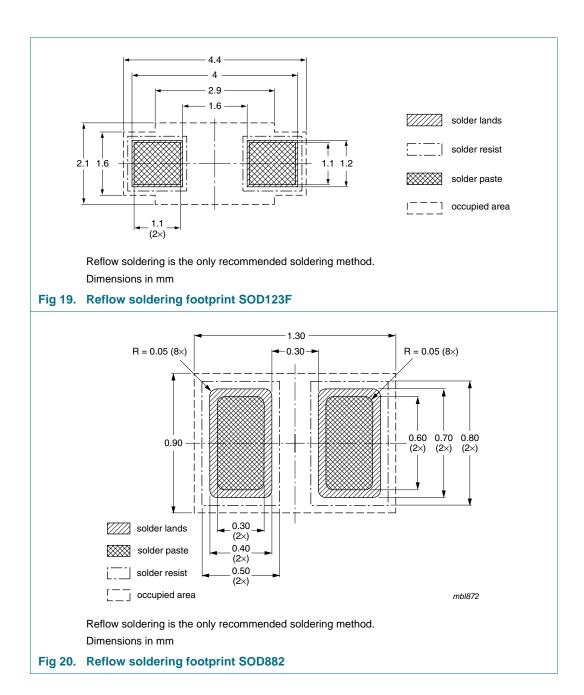
<sup>[2]</sup> T1: normal taping

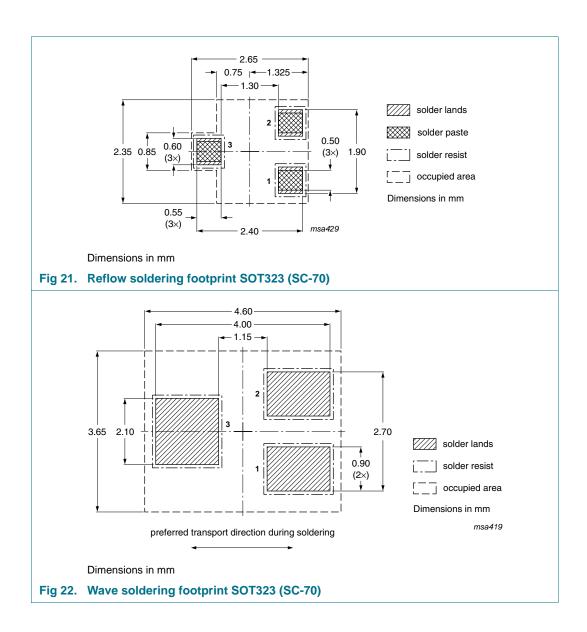
<sup>[3]</sup> T2: reverse taping

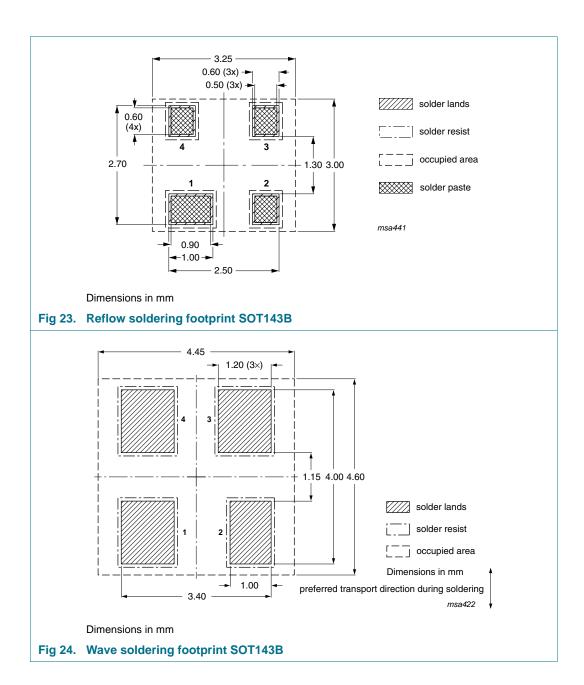
## 10. Soldering

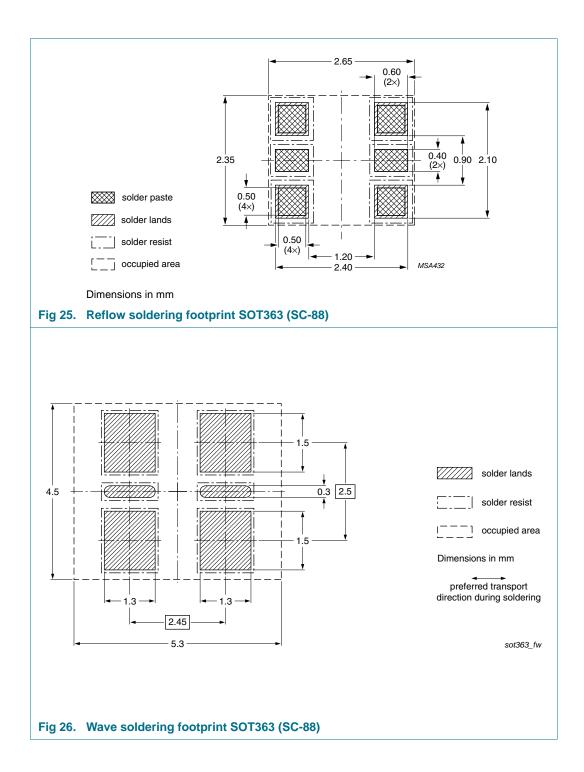


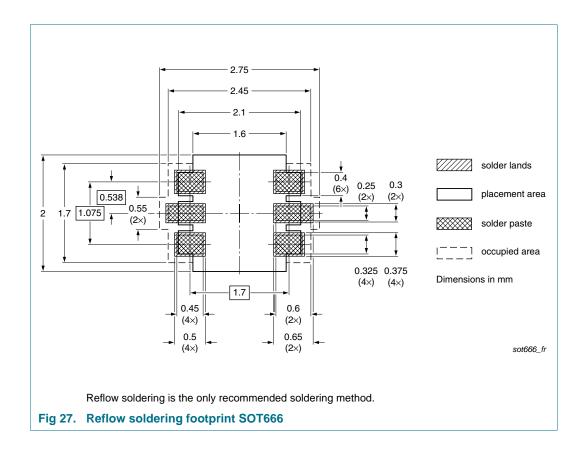












## 11. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAS70_1PS7XSB70_SER_9	20100113	Product data sheet	-	BAS70_1PS7XSB70_SER_8
Modifications:				y name NXP Semiconductors, ges were made to the technical
BAS70_1PS7XSB70_SER_8	20060504	Product data sheet	-	BAS70_1PS7XSB70_SER_7
BAS70_1PS7XSB70_SER_7	20050718	Product data sheet	-	1PS76SB70_2 1PS79SB70_1 BAS70H_1 BAS70L_1 BAS70-07V_1 BAS70VV_1 BAS70W_3 BAS70-07S_4 BAS70_SERIES_6
1PS76SB70_2	20040126	Product specification	-	1PS76SB70_1
1PS79SB70_1	19980716	Product specification	-	-
BAS70H_1	20050425	Product data sheet	-	-
BAS70L_1	20030520	Product specification	-	-
BAS70-07V_1	20020117	Product specification	-	-
BAS70VV_1	20040910	Product data sheet	-	-
BAS70W_3	19990326	Product specification	-	BAS70W_2
BAS70-07S_4	20030411	Product specification	-	BAS70_07S_3
BAS70_SERIES_6	20011011	Product specification	-	BAS70_5

## BAS70 series; 1PS7xSB70 series

**General-purpose Schottky diodes** 

### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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#### **NXP Semiconductors**

## BAS70 series; 1PS7xSB70 series

**General-purpose Schottky diodes** 

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